

AMENDMENTS TO THE SPECIFICATION:

Please amend the specification as follows:

Please amend the paragraph beginning at page 25, line 1 of the specification to read:

The pressing member 26 includes a proximal end section 26E having a hole to ~~be inserted~~ receive connecting pin 32, ~~an~~ a touch portion 26T ~~selectively to be in to~~ selectively contact with the outer peripheral region of the semiconductor device 36, and a coupling section 26C for coupling the proximal end section 26E to the touch portion 26T.

Please amend the paragraph beginning at page 31, line 15 of the specification to read:

In this regard, in the embodiments shown in Figs. 7, 8, and 9 ~~40~~, the semiconductor device sockets adjacent to each other are arranged in a row so that the pressing members 28 and 26 are opposed to each other. However, the arrangement should not be limited thereto but may be in a staggered manner so that the pressing members 28 and 26 are obliquely opposed to each other as shown in Figs. 10 and 11, for example.

Please amend the paragraph beginning at page 33, line 11 of the specification to read:

In Figs. 14 and 15, the pressing members 48 and 50 are disposed opposite each other in the recesses 20b, respectively, of the socket bodies 20. The pressing member

48 includes a proximal end section 48E having a hole for ~~being inserted with the~~
receiving connecting pin 32 described above therein, ~~an~~ a touch portion 48T selectively
in contact with the outer peripheral region of the semiconductor device 36 or 42, and a
connecting section 48C for coupling the proximal end section 48E with the touch portion
48T.